BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin





ATS Part#: ATS015015004-SF-4C

Description: 15.00 x 15.00 x 4.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin

Heat Sink Attachment: N/A
Equivalent Part Number: N/A

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- · Fabricated from extruded aluminum, which minimizes thermal resistance from the base to the fins, reduces weight and keeps costs low
- · Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- · Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	47.08 °C/W	40.2 °C/W	35.9 °C/W	32.8 °C/W	30.4 °C/W	28.5 °C/W	27 °C/W
	Ducted Flow	27.5	23.1	20.4	18.5	17	15.9	15

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	15.00 mm	15.00 mm	4.00 mm	15 mm	N/A	BLACK-ANODIZED
*Image above is for illustration purpose only.	Dimension Dimension Thermal papplicatio ATS reserperformar ATS certification ATS certification ATS certification Thermal papplication ATS certification Thermal papplication Th	n D is fin tip to fin tip performance data are n. rves the right to upd nce.	neight from the botto e provided for refere ate or change its pro	m of the base to the nce only. Actual periducts without notice -6 and REACH comble.	ormanc to impr	e may vary by





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